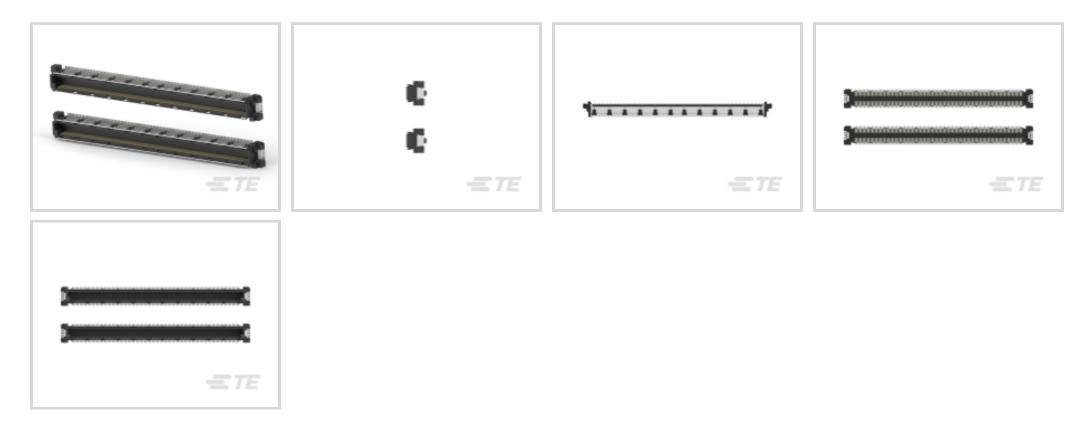
3-1827233-6 - ACTIVE

Free Height

TE Internal #: 3-1827233-6 PCB Mount Header, Vertical, Board-to-Board, 440 Position, .5 mm [. 02 in] Centerline, Gold, Surface Mount, Signal, Black, Tray, Free Height

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 440

Centerline (Pitch): .5 mm [.02 in]

Features



Product Type Features

Ground Feature Type	Grounding Contact, Grounding Plate
PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	Yes
PCB Mount Orientation	Vertical
Number of Positions	440
Board-to-Board Configuration	Parallel
Electrical Characteristics	
Dielectric Withstanding Voltage (Max)	200 VAC
Insulation Resistance	4 MΩ
Operating Voltage	50 VAC
Body Features	

PCB Mount Header, Vertical, Board-to-Board, 440 Position, .5 mm [.02 in] Centerline, Gold, Surface Mount, Signal, Black, Tray, Free Height



Primary Product Color	Black
Contact Features	
Contact Mating Area Length	1 mm, 1.3 mm
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]
Contact Layout	Matrix
Mating Tab Width	.33 mm[.013 in]
Mating Tab Thickness	.2 mm[.008 in]
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.2 μm[7.874 μin]
Contact Type	Pin
Contact Current Rating (Max)	.5 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.71 mm[.028 in]
Termination Method to Printed Circuit Board	Surface Mount
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
PCB Mount Retention Type	Solder Peg
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	With
PCB Mount Alignment	With
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	.5 mm[.02 in]
Housing Material	High Temperature Thermoplastic
Dimensions	
Connector Height	4.45 mm[.175 in]
Stack Height	5 mm[.197 in]

PCB Mount Header, Vertical, Board-to-Board, 440 Position, .5 mm [.02 in] Centerline, Gold, Surface Mount, Signal, Black, Tray, Free Height



	.2 in
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-40 – 85 °C[-40 – 185 °F]
Operation/Application	
Assembly Process Feature	None
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	72
Packaging Method	Tray
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240) Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 245°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

PCB Mount Header, Vertical, Board-to-Board, 440 Position, .5 mm [.02 in] Centerline, Gold, Surface Mount, Signal, Black, Tray, Free Height



Compatible Parts

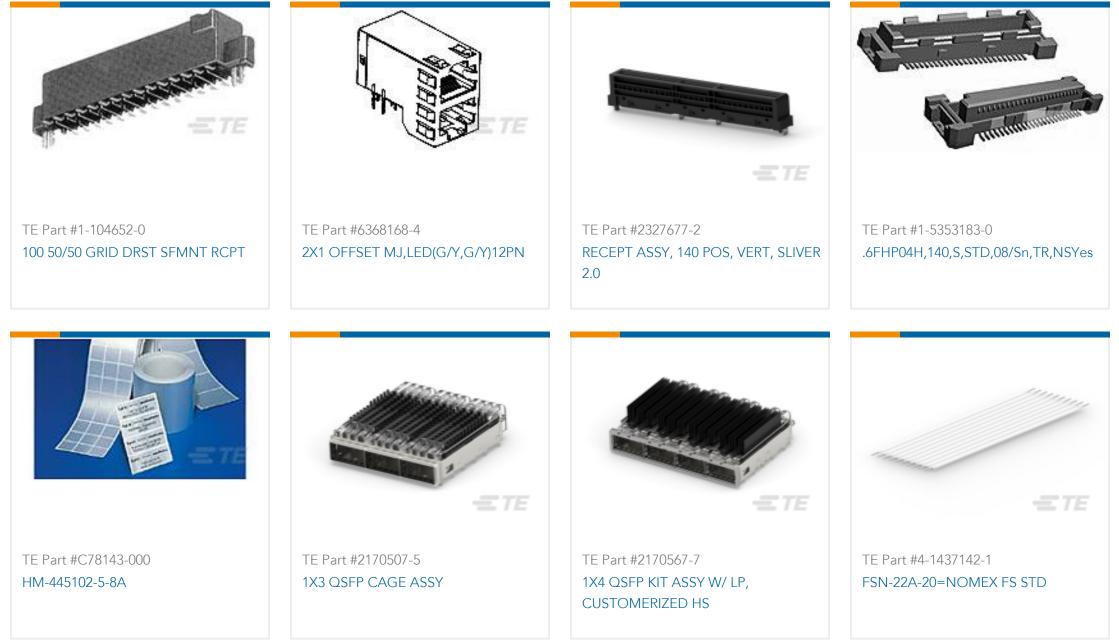


Also in the Series | Free Height



PCB Headers & Receptacles(758)

Customers Also Bought









PCB Mount Header, Vertical, Board-to-Board, 440 Position, .5 mm [.02 in] Centerline, Gold, Surface Mount, Signal, Black, Tray, Free Height





Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_3-1827233-6_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_3-1827233-6_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_3-1827233-6_A.3d_stp.zip

English

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Datasheets & Catalog Pages

Fine Pitch Stacking Connectors - 0.5mm Free Height (FH) Connectors

English

COM Connectors Brochure (English)

English

Product Specifications

Product Specification

English

0.5mm Pitch Board to Board Connector, Free Height Type

English